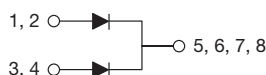


# High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.56\text{ V}$  at  $I_F = 2.5\text{ A}$



FlatPAK 5 x 6



## DESIGN SUPPORT TOOLS AVAILABLE



| PRIMARY CHARACTERISTICS                               |                |
|---|----------------|
| $I_{F(AV)}$   | 2 x 5 A        |
| $V_{RRM}$   | 150 V          |
| $I_{FSM}$   | 100 A          |
| $V_F$ at $I_F = 5\text{ A}$ ( $T_A = 125\text{ °C}$ ) | 0.63 V         |
| $T_J$ max.  | 150 °C         |
| Package   | FlatPAK 5 x 6  |
| Circuit configuration                                 | Common cathode |

## FEATURES

- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
FREE

## TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

## MECHANICAL DATA

**Case:** FlatPAK 5 x 6

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

| MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)                               |                   |             |      |
|--|-------------------|-------------|------|
| PARAMETER  | SYMBOL            | V10K150C    | UNIT |
| Device marking code  |                   | V1015C      |      |
| Maximum repetitive peak reverse voltage  | $V_{RRM}$         | 150         | V    |
| Maximum DC forward current per device  | $I_{F(AV)}^{(1)}$ | 10          | A    |
|  | $I_{F(AV)}^{(2)}$ | 3           | A    |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode | $I_{FSM}$         | 100         | A    |
| Operating junction temperature range   | $T_J^{(3)}$       | -40 to +150 | °C   |
| Storage temperature range  | $T_{STG}$         | -55 to +150 | °C   |

### Notes

(1) With infinite heatsink

(2) Free air, mounted on recommended pad area

(3) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                               | TEST CONDITIONS        |                         | SYMBOL                        | TYP. | MAX. | UNIT |
|---|------------------------|-------------------------|-------------------------------|------|------|------|
| Instantaneous forward voltage per diode | I <sub>F</sub> = 2.5 A | T <sub>A</sub> = 25 °C  | V <sub>F</sub> <sup>(1)</sup> | 0.74 | -    | V    |
|   | I <sub>F</sub> = 5 A   |                         |                               | 1    | 1.08 |      |
|   | I <sub>F</sub> = 2.5 A | T <sub>A</sub> = 125 °C |                               | 0.56 | -    |      |
|   | I <sub>F</sub> = 5 A   |                         |                               | 0.63 | 0.71 |      |
| Reverse current per diode               | V <sub>R</sub> = 100 V | T <sub>A</sub> = 25 °C  | I <sub>R</sub> <sup>(2)</sup> | 0.01 | -    | mA   |
|   |                        | T <sub>A</sub> = 125 °C |                               | 1.5  | -    |      |
|   | V <sub>R</sub> = 150 V | T <sub>A</sub> = 25 °C  |                               | -    | 0.2  |      |
|   |                        | T <sub>A</sub> = 125 °C |                               | 3    | 8    |      |
| Typical junction capacitance per diode  | 4.0 V, 1 MHz           |                         | C <sub>J</sub>                | 400  | -    | pF   |

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: pulse width  $\leq 5\text{ ms}$ **THERMAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                     | SYMBOL                   | TYP. | MAX. | UNIT                 |
|-------------------------------|--------------------------|------|------|----------------------|
| Thermal resistance per device | $R_{\theta JA}^{(1)(2)}$ | 75   | -    | $^{\circ}\text{C/W}$ |
|                               | $R_{\theta JM}^{(3)}$    | 2.5  | 3.5  |                      |

**Notes**(1) The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ (2) Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction-to-ambient(3) Mounted on infinite heat sink; thermal resistance  $R_{\theta JM}$  - junction-to-mount**ORDERING INFORMATION** (Example)

| PREFERRED P/N                | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
|------------------------------|-----------------|------------------------|---------------|------------------------------------|
| V10K150C-M3/H                | 0.10            | H                      | 1500          | 7" diameter plastic tape and reel  |
| V10K150C-M3/I                | 0.10            | I                      | 6000          | 13" diameter plastic tape and reel |
| V10K150CHM3/H <sup>(1)</sup> | 0.10            | H                      | 1500          | 7" diameter plastic tape and reel  |
| V10K150CHM3/I <sup>(1)</sup> | 0.10            | I                      | 6000          | 13" diameter plastic tape and reel |

**Note**

(1) AEC-Q101 qualified

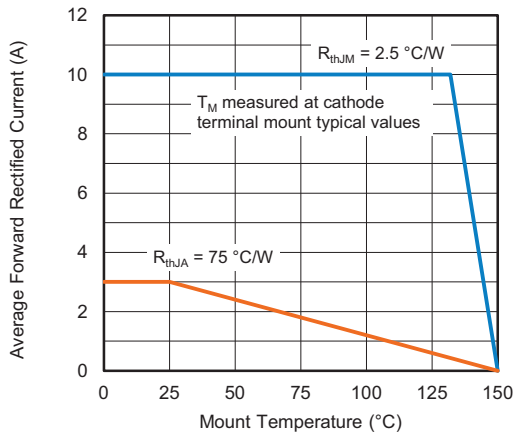
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

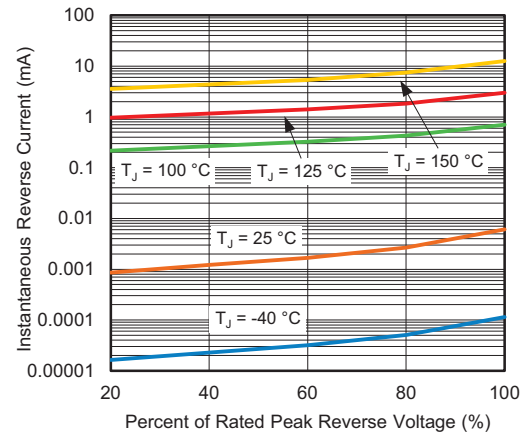


Fig. 4 - Typical Reverse Leakage Characteristics

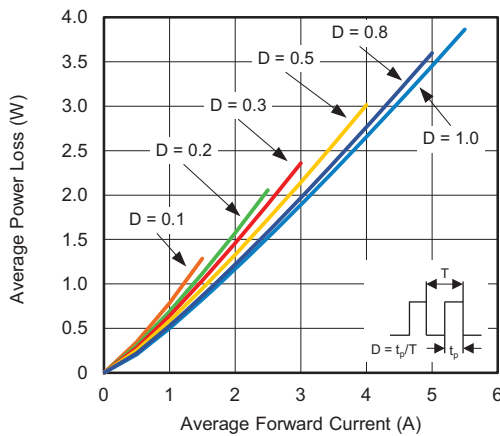


Fig. 2 - Forward Power Loss Characteristics

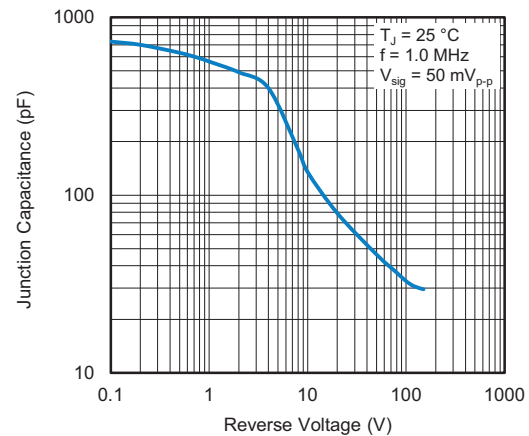


Fig. 5 - Typical Junction Capacitance

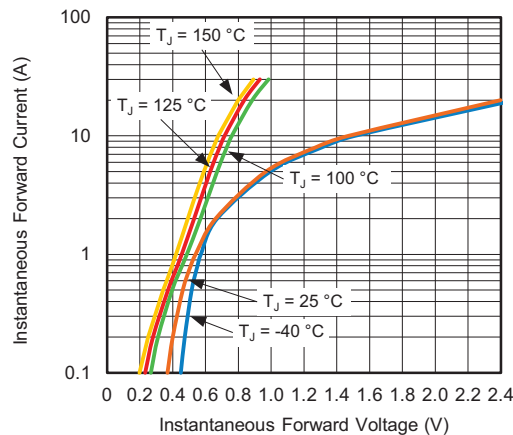


Fig. 3 - Typical Instantaneous Forward Characteristics

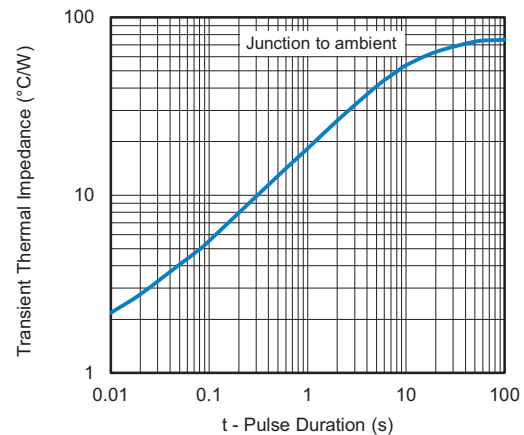
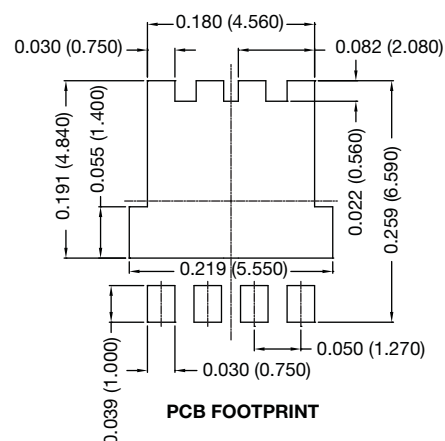


Fig. 6 - Typical Transient Thermal Impedance

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)**FlatPAK 5 x 6****TOP VIEW****BOTTOM VIEW****PCB FOOTPRINT****SIDE VIEW**

| DIM. | INCHES    |       |       | MILLIMETERS |       |      |
|------|-----------|-------|-------|-------------|-------|------|
|      | MIN.      | NOM.  | MAX.  | MIN.        | NOM.  | MAX. |
| A    | 0.035     | 0.039 | 0.043 | 0.89        | 0.99  | 1.09 |
| (a)  | -         | 0.006 | -     | -           | 0.15  | -    |
| b    | 0.013     | 0.017 | 0.020 | 0.32        | 0.43  | 0.52 |
| b1   | 0.013     | 0.017 | 0.020 | 0.32        | 0.43  | 0.52 |
| c    | 0.008     | -     | 0.014 | 0.20        | -     | 0.35 |
| D    | 0.197     | 0.203 | 0.209 | 5.00        | 5.15  | 5.30 |
| D1   | 0.189     | 0.193 | 0.197 | 4.80        | 4.90  | 5.00 |
| D2   | 0.154     | 0.161 | 0.169 | 3.90        | 4.10  | 4.30 |
| (d1) | -         | 0.016 | -     | -           | 0.40  | -    |
| (d2) | -         | 0.005 | -     | -           | 0.125 | -    |
| E    | 0.238     | 0.244 | 0.250 | 6.05        | 6.20  | 6.35 |
| E1   | 0.228     | 0.232 | 0.236 | 5.80        | 5.90  | 6.00 |
| E2   | 0.157     | 0.165 | 0.173 | 4.00        | 4.20  | 4.40 |
| (E3) | -         | 0.144 | -     | -           | 3.65  | -    |
| e    | 0.050 BSC |       |       | 1.27 BSC    |       |      |
| (K)  | 0.039     | -     | -     | 1.00        | -     | -    |
| L1   | 0.019     | -     | 0.043 | 0.48        | -     | 1.10 |
| L2   | 0.012     | -     | 0.031 | 0.30        | -     | 0.80 |
| M    | 0.128     | 0.138 | 0.148 | 3.25        | 3.50  | 3.75 |
| Θ    | 0°        | -     | 10°   | 0°          | -     | 10°  |

**Notes**

- Dimensioning and tolerancing per ASME Y14.5-2009
- Dimensions D1 and E1 do not include mold flash or gate burrs
- Dimension (XX) means reference only



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